RTKA-BDGSTKEV2Z

User's Manual: Evaluation Board

Industrial Analog and Power

Renesas Electronics Corporation

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RTKA-BDGSTKEV2Z

Evaluation Board

The DAQ on a Stick, Renesas Strain Gauge is one of a series of reference designs highlighting Renesas precision products. This reference design is a self contained demonstration showing a complete signal chain solution using Renesas precision parts and a Renesas microcontroller. The complete reference design is conveniently housed in a USB stick form factor. This compact design draws power through the USB port and uses a Graphical User Interface (GUI) to display the real time voltage readings from a bridge strain gauge or a user supplied sensor. Figure 1 shows the Data Acquisition (DAQ) on a Stick connected to an external foil strain gauge.
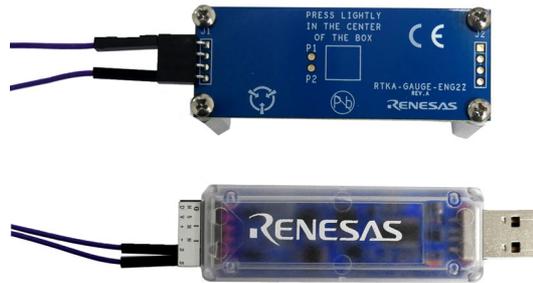

Figure 1. DAQ on a Stick with Strain Gauge

Figure 2 shows a simplified schematic of the Strain Gauge design. The design uses the Renesas ISL28134 chopper amplifier, ISL22316 Digitally Controlled Potentiometer (DCP), ISL43840 dual 4-channel Mux configured as a Differential Mux, ISL21010 3.3V and 4.096V precision voltage references, ISL26102 24-bit delta sigma converter, and the R5F10JBC microcontroller.

Ordering Information

Part Number	Description
RTKA-BDGSTKEV2Z	Evaluation Board

Related Literature

For a full list of related documents, visit our website:

• ISL28134, ISL21010, ISL26102, ISL43840, ISL22316, and R5F10JBC device pages
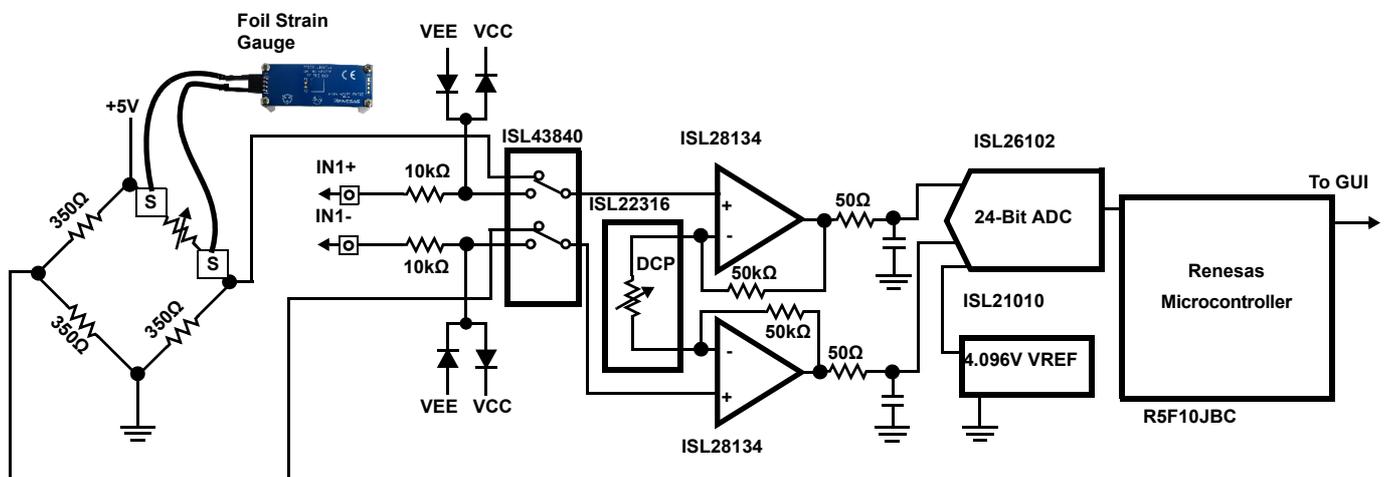

Figure 2. Simplified Strain Gauge SchematiC

1.   Getting Started

1.1   Installing the Software and USB Drivers

Download the software and a short video on the operation of this application from the Renesas website.

The software and USB drivers must be installed on a PC running Windows NT/2000/XP/Vista/Win7/Win 8/Win 10 operating system before connecting the RTKA-BDGSTKEV2Z evaluation board to the USB port.

1.2   Loading the Software

1. Click the Renesas DAQ on a Stick Software link to load the executable.

2. Follow the on-screen instructions to complete the software installation. The installation program places the user interface software in the C:\Program Files\R12UZ0045_DAQ_V250 directory.

3. To create a shortcut on your desktop, check the **Create A Desktop Icon** box during the software installation.

4. Launch the application by checking the **Launch R12UZ0045_DAQ_V250** box, then click **Finish**.

1.3   Running the Evaluation Software

1. After installing the software, plug the RTKA-BDGSTKEV2Z board into a USB port on the computer and click the Renesas DAQ shortcut (created in "Loading the Software") on the desktop. Figure 3 shows the desktop icon.
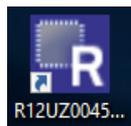

Figure 3. Desktop Icon

2. The green LED on the DAQ on a Stick board turns on. When the software starts, the DAQ Startup screen shown in Figure 5 on page 4 appears. With the board connected, the USB Status indicator displays "Connected 0x2032". The assigned HID code 0x2032 is verification that the software is communicating with the board.

Note: If the DAQ on a Stick is not connected, or a problem exists with the demonstration, the USB Status indicator displays "HID Device Not Found". If this message appears, click **Test USB Connection** to enable the connection. If the connection is still not enabled, disconnect and reconnect the device or restart the software.

3. From the DAQ Startup Screen (Figure 5), click **Instantaneous Voltage** to get a single voltage reading, select the sensor input to measure, and adjust the amplifier gain.

4. Click **Start** to go to the Measurement Display screen shown in Figure 6. The green LED on the board turns off.

1.4   Connecting the Sensor

The RTKA-BDGSTKEV2Z reference design provides the option to measure the strain on a foil gauge (supplied with the evaluation board) or connect your own sensor and monitor the voltage reading in the software. Select **Sensor Supplied with the Demo** or **Customer Supplied** sensor by clicking the appropriate radio button on the DAQ Startup Screen (see Figure 5). The foil gauge is the default value in the software with a gain of 115V/V. Figure 4 shows the external connector inputs that connect the sensor to the circuit shown in Figure 2.
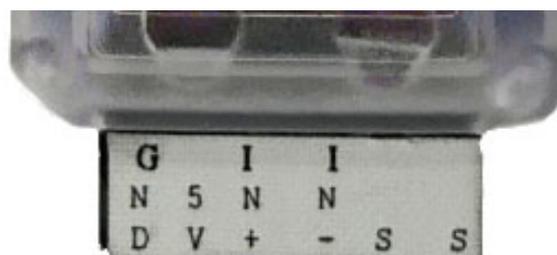

Figure 4. Sensor Connector

1.4.1 Connecting the Foil Strain Gauge

The foil gauge is supplied with the evaluation board. Complete the following steps to connect the foil gauge.

1. Plug the wires into the "S" ports (either top row or the bottom row; the columns are connected) on the DAQ on a Stick.

2. Connect the opposite end of the wires to the far edges of the foil gauge board. See Figure 5.

1.4.2 Connecting the User Supplied Sensor

To connect your own sensor, complete the following steps.

1. Plug the wires into the IN+ and IN- ports shown in Figure 4.

2. Select **Customer Supplied** in the DAQ Startup Screen, as shown in Figure 5. This selection causes the ISL43840 configured as a differential mux to switch the inputs. When the **Customer Supplied** option is selected, you can change the amplifier gain for the best measurement.

3. The DAQ on a Stick also provides a 5V supply and Ground connection for possible use by your sensor network.
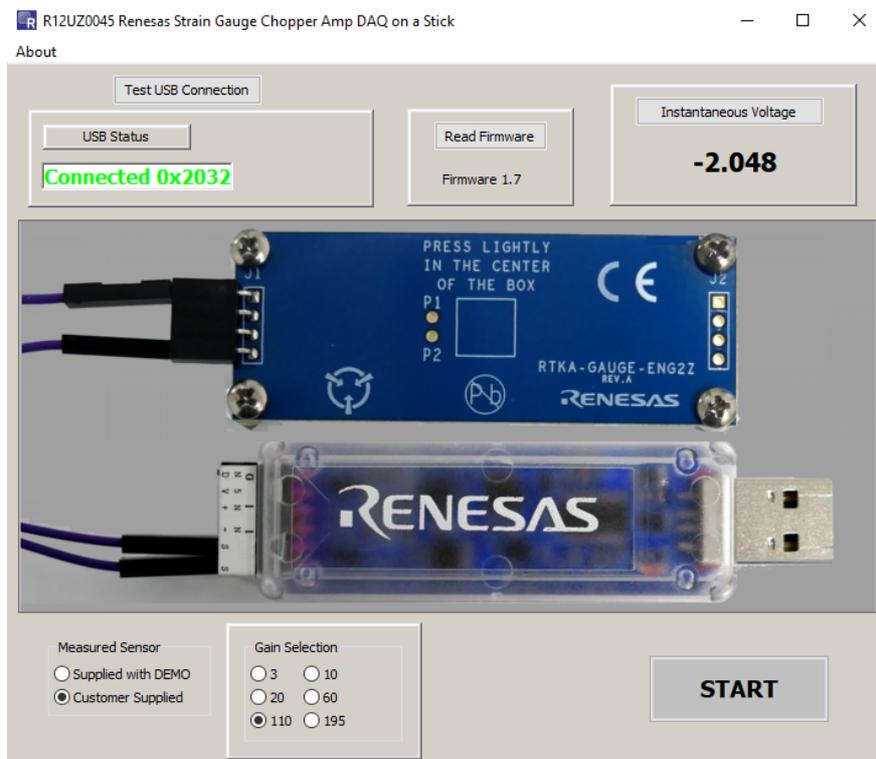
Figure 5. DAQ Startup Screen

Figure 6 shows the Measurement Display screen. From this screen, you can stop and start data collection, adjust the minimum and maximum X and Y axis, and go back to the setup screen by clicking Show Main. The Calibrate button zeroes out the voltage reading when the board is not under strain.

Calibration helps to give an accurate reading from time zero and is required because the board does not always return to the same deflection point after a strain is applied to the board.

Figure 6. Measurement Display Screen

2. Design Considerations

2.1 ISL28134

The ISL28134 is an ideal choice for the input amplifier for a strain gauge design. The ISL28134 uses auto-correction circuitry to provide ultra low offset voltage (2.5µV) and low offset temperature drift (15nV/°C). The very low 1/f noise corner (<0.1Hz) and low input noise voltage (8nV/√Hz at 100Hz) of the amplifier makes the ISL28134 ideal for low frequency precision applications requiring very high gain and low noise. Other key features of the ISL28134 are the wide gain bandwidth and rail-to-rail input/output swing.

2.2 ISL26102 24-Bit ADC

The ISL26102 is a complete analog front-end with dual differential multiplexed inputs for high resolution measurements. The ISL26102 features a third order modulator providing up to 21.4-bit noise-free performance (10Sps). The 24-bit delta-sigma analog-to-digital converter includes a very low-noise amplifier with programmable gain. Although this application demonstration uses an input buffer amplifier (ISL28134), the high input impedance of the ISL26102 allows direct connection of sensors such as load cell bridges to ensure the specified measurement accuracy without a buffer amplifier.

To initiate a correct power-up reset, diode D1, resistor R_3 and capacitor C_8 implement a simple RC delay to ensure the $\overline{PDWN}$ transitions from low to high after both power supplies have settled to specified levels.

2.3 ISL21010 (3.3V) Voltage Reference

The ISL21010CFH333 is a precision 3.3V, low dropout micropower band-gap voltage reference, which provides a ±0.2% accurate reference. The ISL21010 provides up to 25mA output current sourcing with low 150mV dropout voltage. The low supply current and low dropout voltage combined with high accuracy make the ISL21010 ideal for precision low powered applications.

2.4 ISL21010 (4.096V) Voltage Reference

The ISL21010CFH341 is a precision 4.096V, low dropout micropower band-gap voltage reference, which provides a ±0.2% accurate reference. The ISL21010 provides up to 25mA output current sourcing with low 150mV dropout voltage. The low supply current and low dropout voltage combined with high accuracy make the ISL21010 ideal for precision low powered applications.

2.5 ISL22316 DCP

The ISL22316 is a low noise, low power I^{2}C™ bus, 128 tap DCP. The DCP can be used as a three-terminal potentiometer or as a two-terminal variable resistor in a wide variety of applications including control, parameter adjustments, and signal processing.

2.6 ISL43840 Low-Voltage, Dual 4-to-1 Multiplexer

The ISL43840 is a precision, bidirectional, analog switch configured as a dual 4-channel multiplexer/demultiplexer. In this design, the mux is configured as a differential mux. The mux is designed to operate from a single +2V to +12V supply or from a ±2V to ±6V supply. The ISL43840 has low charge injection with 1pC (maximum) at VS = ±5V.

2.7 Bill of Materials

Part Number	Ref Des	Qty	Value	Tol.	Voltage	PWR	Package Type	JEDEC Type	MFR	Description
GRM21BR71C475KA73L	C1	1	4.7µF	10%	16V		805	CAP_0805	Murata	Ceramic Cap
Generic	C7, C12, C13, C20	4	0.01µF	10%	16V		402	CAP_0402	Various	Multilayer Cap
Generic	C5, C8, C9, C11, C14, C25, C27	7	0.1µF	10%	16V		402	CAP_0402	Various	Multilayer Cap
Generic	C21, C22	2	0.01µF	10%	25V		603	CAP_0603	Various	Multilayer Cap
250R07C100JV4T	C23, C24	2	10pF	5%	25V		402	CAP_0402RF	Johanson-Tech	C Series High-Q Chip Cap
Generic	C2, C3, C10, C26	4	1µF	20%	16V		603	CAP_0603	Various	Ceramic Cap
Generic	C6	1	0.33µF	10%	25V		603	CAP_0603	Various	Multilayer Cap
Generic	C17, C18	2	OPEN	5%	OPEN		603	CAP_0603	Various	Multilayer Cap
Generic	C15	1	2.2µF	10%	16V		805	CAP_0805	Various	Multilayer Cap
Generic	C4	1	10µF	10%	16V		1206	CAP_1206	Various	Multilayer Cap
597-3311-407	D1	1					SMD	DIA_LED1206	Dialight	Surface Mount Green LED
BAT54	D2	1					SINGLE	SOT23	Diodes	30V Schottky Diode
MMSD4148T1	D3 - D6	4					SOD123	SOD123	ON-Semi	Switching Diode
48037-1000	J1	1					MOLEX1	CON_USB_MOLEX_480371000	Molex	Right Angle USB A-Type Receptacle
PPPC062LJBN-RC	J2	1					DIP	CONN12	Sullins	12 Pin Header 2.54mm x 2.54mm (.100) Connector RA
251206102Y1	L1	1	1µH				SMD	SM1206	Fair-Rite	Ferrite Bead
Generic	R7, R11, R27	3	0	0%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R2, R3	2	100	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R8	1	1k	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R1, R4, R15, R16	4	10k	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R28	1	220	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R5, R6, R31	3	4.99k	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R12, R13	2	49.9k	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor
Generic	R9, R10	2	49.9	1%		1/16W	402	RES_0402	Various	Thick Film Chip Resistor

Part Number	Ref Des	Qty	Value	Tol.	Voltage	PWR	Package Type	JEDEC Type	MFR	Description
Generic	R30	1	DNP	0.1		DNP	603	RES_0603	Various	Thick Film Chip Resistor (Do Not Populate)
Generic	R14, R29	2	DNP	1%		DNP	402	RES_0402	Various	Thick Film Chip Resistor (Do Not Populate)
Generic	R20, R23, R26	3	1	0.1%		1/10W	805	RES_0805	Various	Thick Film Chip Resistor
Generic	R19, R22, R25	3	100	0.1%		1/10W	805	RES_0805	Various	Thick Film Chip Resistor
Generic	R18, R21, R24	3	249	0.1%		1/10W	805	RES_0805	Various	Thick Film Chip Resistor
ISL26102AVZ	U1	1					TSSOP	TSSOP24_173_256	Renesas	24 Pin 173 Mil TSSOP Package
ISL21010CFH341Z	U2	1					SOT	SOT23-3	Renesas	3 Pin SOT23-3 Package
ISL28134FHZ	U3, U4	2					SMD	SOT23-5	Renesas	5 Pin SOT23 Package
ISL43840IRZ	U5	1					QFN	QFN20_157X157_197_EP	Renesas	20 Lead Quad Flat Package (Pb-Free)
ISL22316UFRT	U6	1					DFN3X3B	TDFN10_118X118_197_EPB	Renesas	10 Lead 3 X 3 0.5 Pitch Thin Dual Flat Package with E-Pad
R5F10JBCANA	U7	1					QFN-S	QFN32_197X197_197_EPA	Renesas	32 Lead Quad Flat Package (Pb-Free)
IP422OCZ6	U8	1					SOT457	SOT457	NXP	Dual USB 2.0 Integrated ESD Protection
ISL54054IRUZ	U9	1					1_2X1A	UTDFN6_47X39_157_A	Renesas	6 Pin UTDFN-1.2X1A 0.4 Pitch Package
ISL21010CFH333Z	U10	1					SOT	SOT23-3	Renesas	3 Pin SOT23-3 Package
MCR03EZPFX3001	R17	1	3k	1%		1/10W	603	RES_0603	ROHM	Metal Film Chip Resistor
PAD_50	P1, P2	2					THOLE	PAD-50	Various	0.050 Pad with 0.031 Plated Thru Hole
NX5032GA-12.000M-LN-CD-1	Y1	1					SM	XTAL_NX5032GA	NDK	12.000MHz SM Crystal

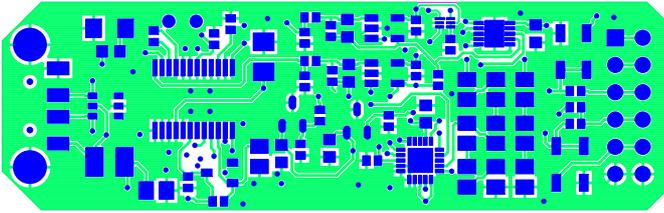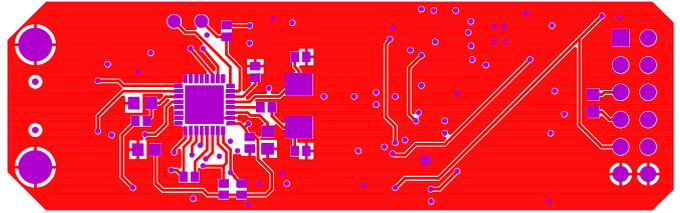## 2.8   RTKA-BDGSTKEV2Z Evaluation Board Layout
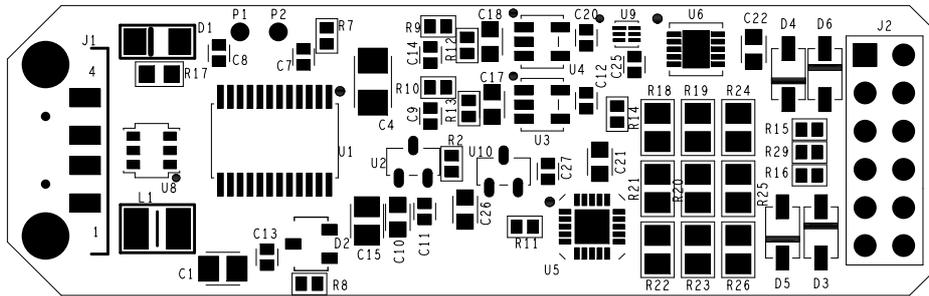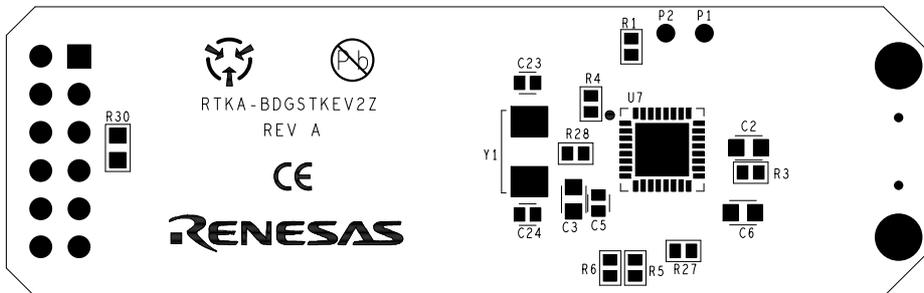

Figure 7. Top Layer

Figure 8. Bottom Layer

Figure 9. Top Assembly Drawing
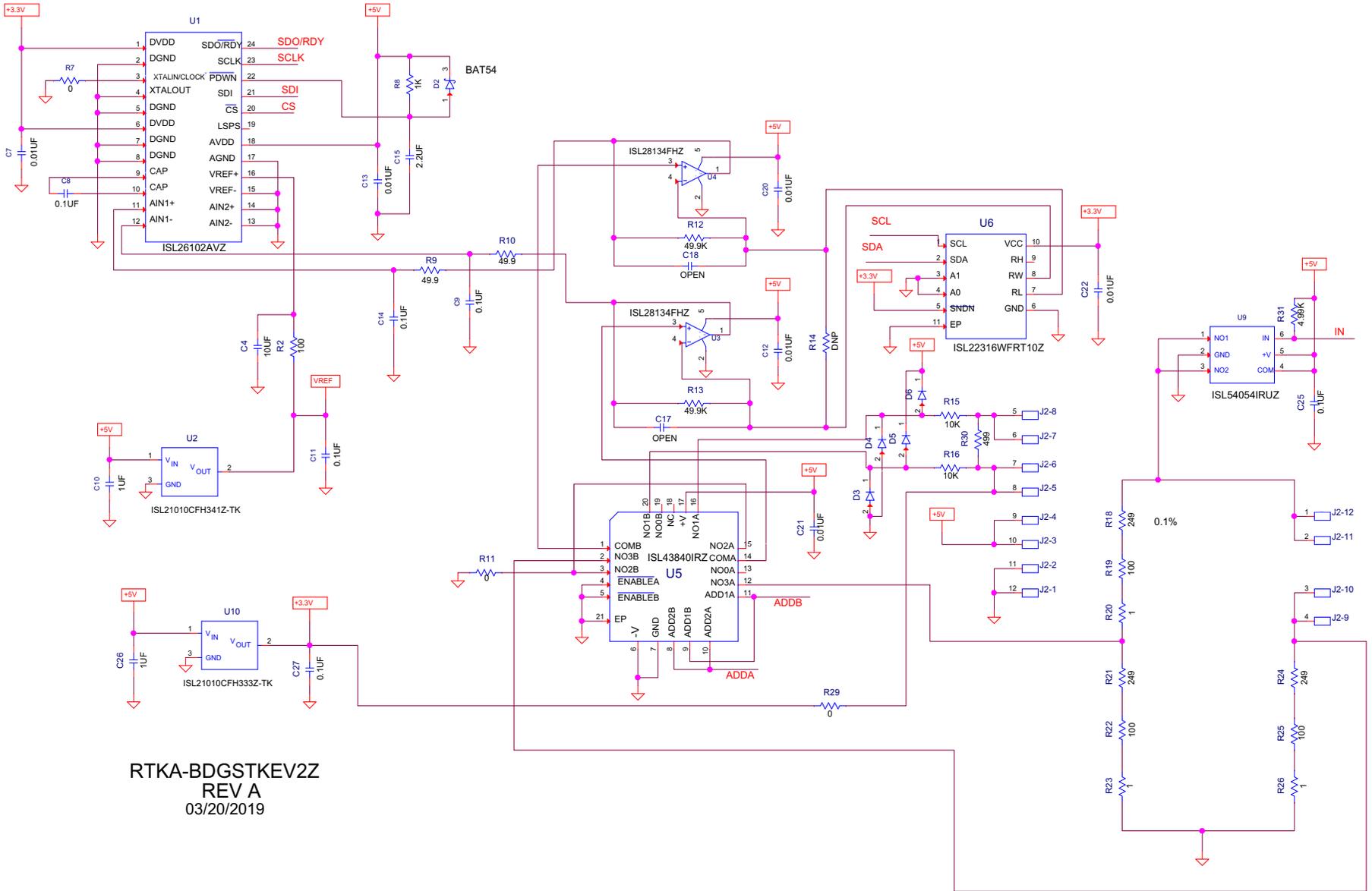

Figure 10. Bottom Assembly Drawing

2.9   RTKA-BDGSTKEV2Z Schematic

Figure 11. RTKA-BDGSTKEV2Z Strain Gauge Schematic

RTKA-BDGSTKEV2Z
REV A
03/20/2019

Figure 12. RTKA-BDGSTKEV2Z MCU Schematic

3. Revision History

Rev.	Date	Description
2.00	Jul.9.19	Updated Bill of Materials
1.01	Jun.5.19	Updated ISL21010 information.
1.00	Apr.5.19	Initial release.

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